

Part Number: APB2012SURKCGKC

Hyper Red  
Green

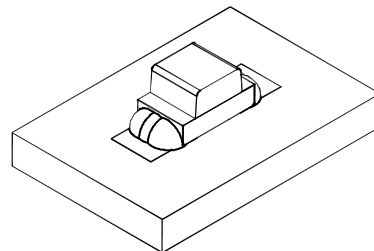
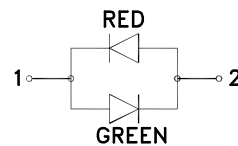
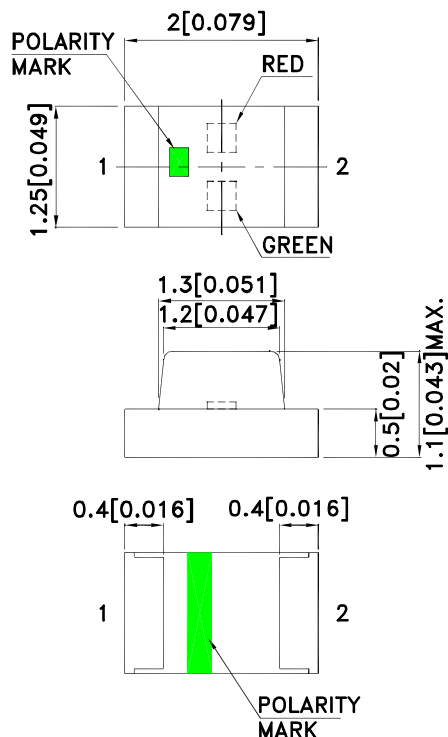
### Features

- 2.0mmx1.25mm SMT LED, 1.1mm thickness.
- Bi -color, Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

The Hyper Red source color devices are made with Al-GaN on GaAs substrate Light Emitting Diode.  
The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

### Package Dimensions



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.15$  (0.006") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



## Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APB2012SURKCGKC	Hyper Red (AlGaInP)	Water Clear	120	200	150°
			*40	*80	
	Green (AlGaInP)		20	50	
			*20	*50	

### Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
- \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 574		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	IF=20mA
C	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	IF=20mA

### Notes:

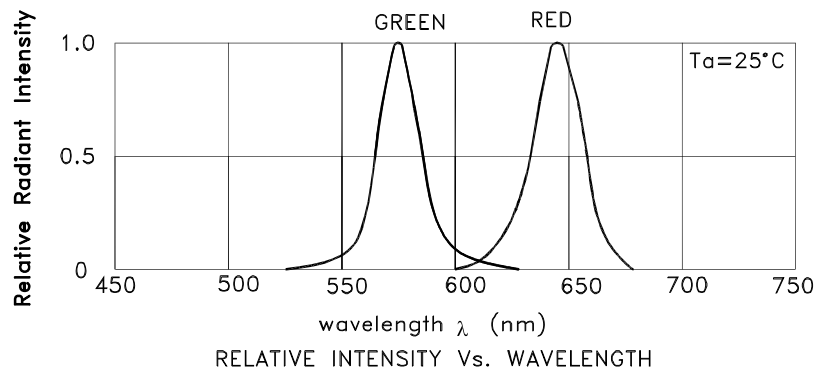
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

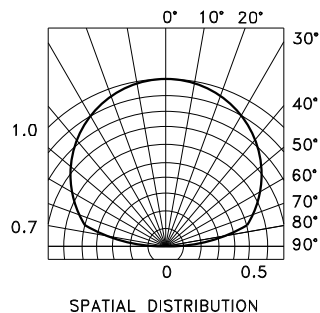
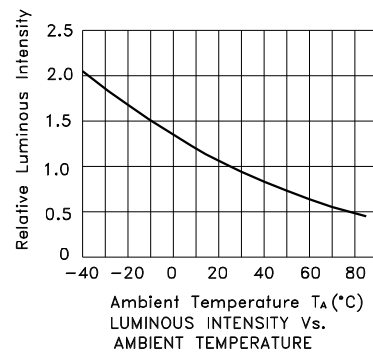
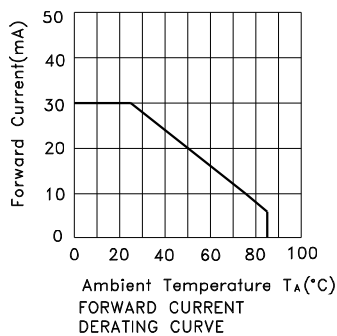
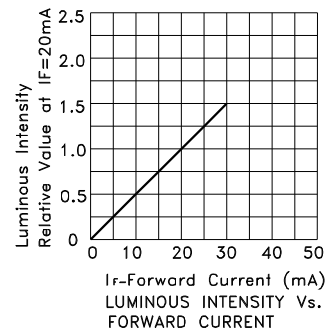
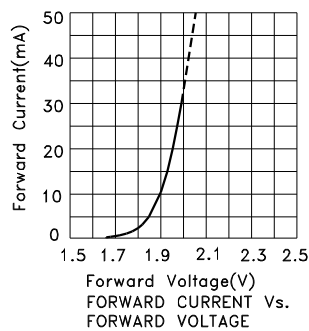
Parameter	Hyper Red	Green	Units
Power dissipation	75	75	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	185	150	mA
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

### Note:

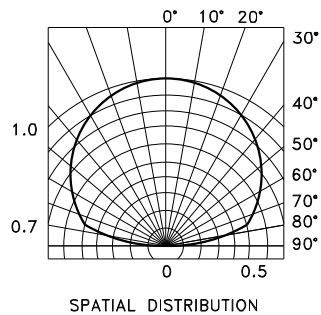
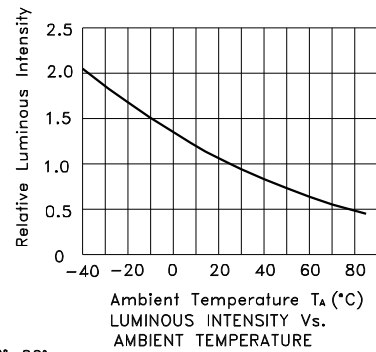
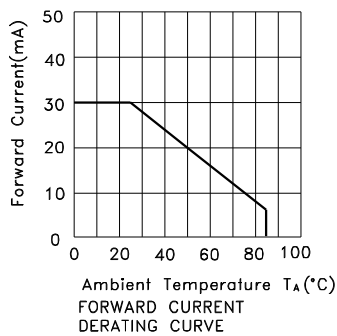
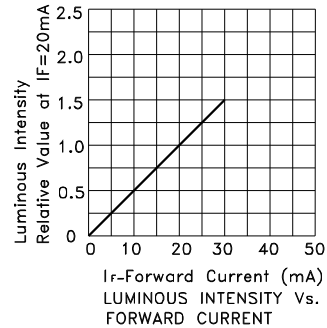
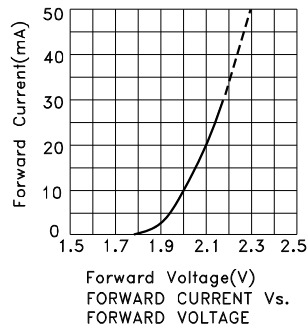
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



## APB2012SURKCGKC Hyper Red



## Green



## APB2012SURKCGKC

Reflow soldering is recommended and the soldering profile is shown below.  
Other soldering methods are not recommended as they might cause damage to the product.

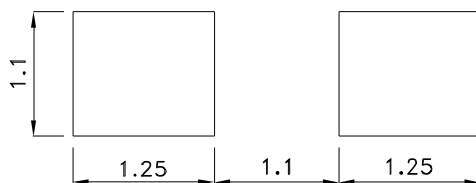
Reflow Soldering Profile For Lead-free SMT Process.



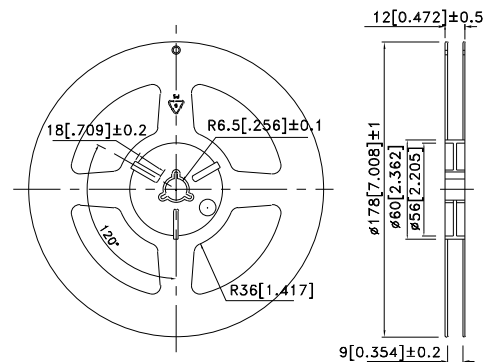
### NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

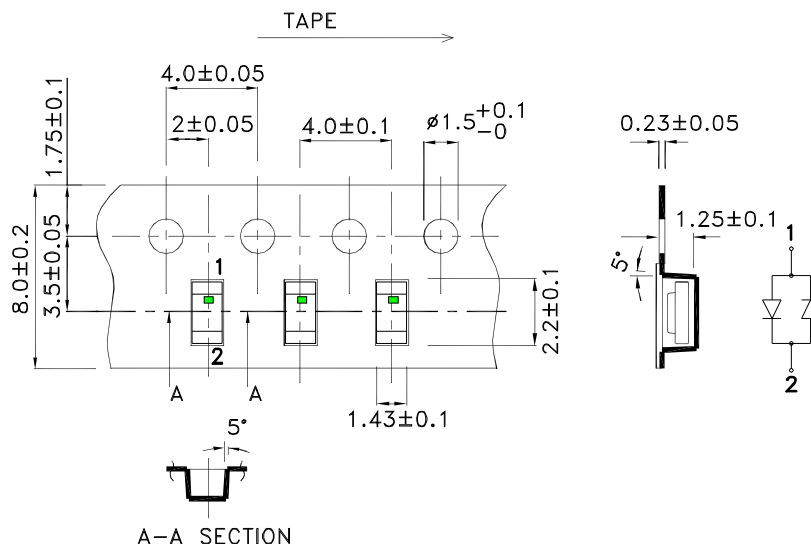
## Recommended Soldering Pattern (Units : mm; Tolerance: $\pm 0.1$ )



## Reel Dimension

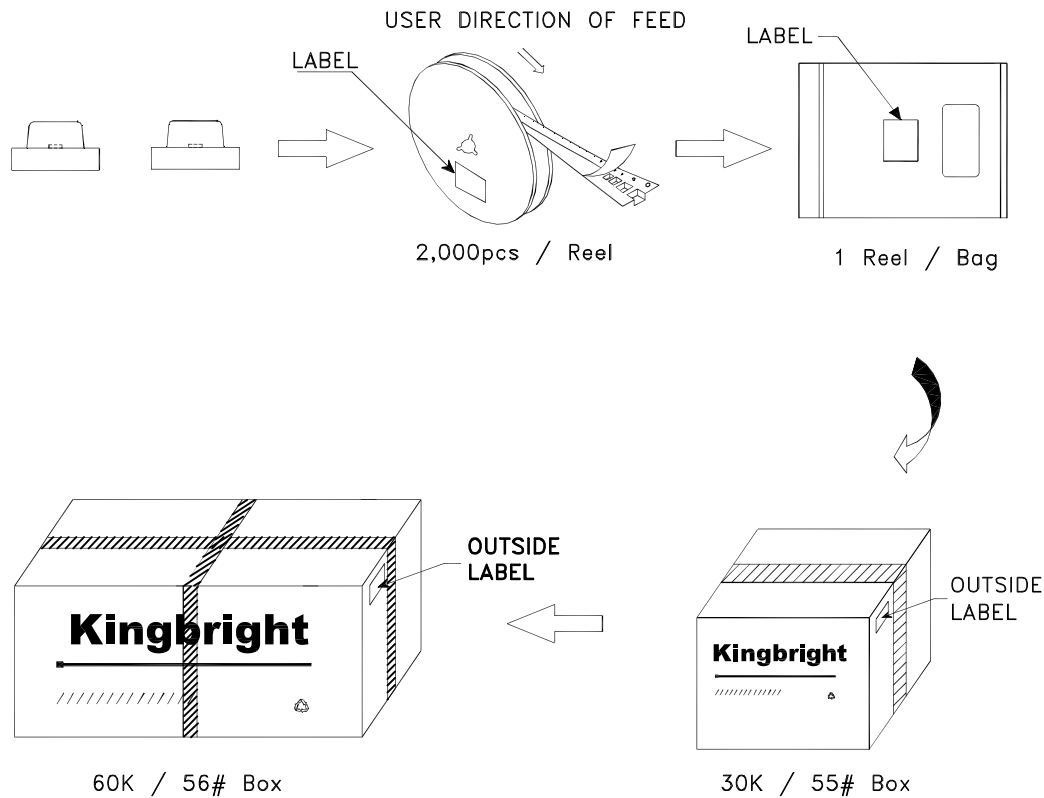



## Tape Dimensions (Units : mm)



## PACKING & LABEL SPECIFICATIONS

APB2012SURKCGKC



<b>Kingbright</b>	
P/NO: APB2012xxx	
QTY: 2,000 pcs	Q.C. <div>QC xx xx xxxx PASSED</div>
S/N: XXXX	
CODE: XXX	
LOT NO:	
 xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx	
RoHS Compliant	

All design applications should refer to Kingbright application notes available at <http://www.KingbrightUSA.com/ApplicationNotes>